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TID #: N/A	Project Title: TPS62136 -12V Inverter	Sheet Title:	
Number: TIDA-01423	Rev: A	Assembly Variant: 001	Sheet: 1 of 2
SVN Rev: Version control disabled	File: TIDA-01423_A.SchDoc	Size: B	
Drawn By: Fred Illguth	Engineer: Michael Helminger	Contact: http://www.ti.com/support	

~~DNP~~ ~~DNP~~
SH-JP1 SH-JP2


~~DNP~~ ~~DNP~~ ~~DNP~~
FID1 FID2 FID3

PCB Number: TIDA-01423
PCB Rev: A

ZZ2
Assembly Note
These assemblies are ESD sensitive, ESD precautions shall be observed.

ZZ3
Assembly Note
These assemblies must be clean and free from flux and all contaminants. Use of no clean flux is not acceptable.

ZZ4
Assembly Note
These assemblies must comply with workmanship standards IPC-A-610 Class 2, unless otherwise specified.

Orderable: PMP???	Designed for: Public Release	Mod. Date: 3/17/2017	 TEXAS INSTRUMENTS http://www.ti.com <small>© Texas Instruments 2017</small>
TID #: N/A	Project Title: TPS62136 -12V Inverter		
Number: TIDA-01423	Rev: A	Sheet: 2 of 2	
SVN Rev: Version control disabled	Assembly Variant: 001	Size: B	
Drawn By: Fred Illguth	File: TIDA-01423_A_Hardware.SchDoc	Contact: http://www.ti.com/support	
Engineer: Michael Helminger			

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